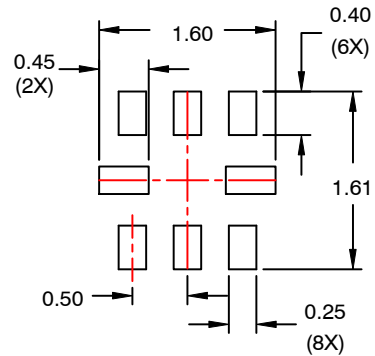
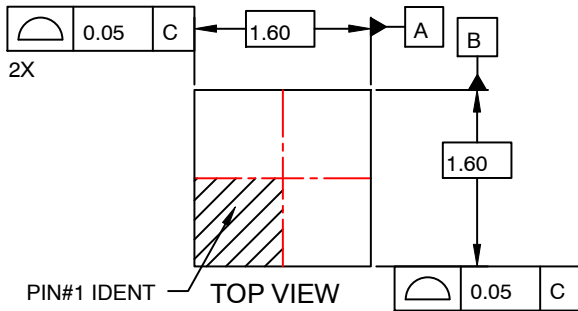




UQFN8 1.6X1.6, 0.5P
CASE 523AY
ISSUE O

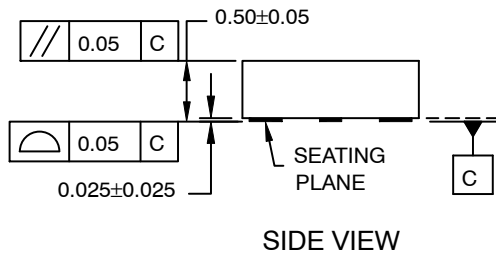
DATE 31 AUG 2016



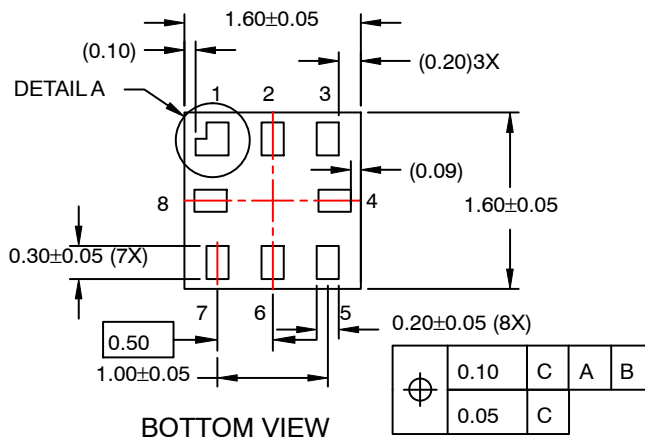
**RECOMMENDED
LAND PATTERN**

NOTES:

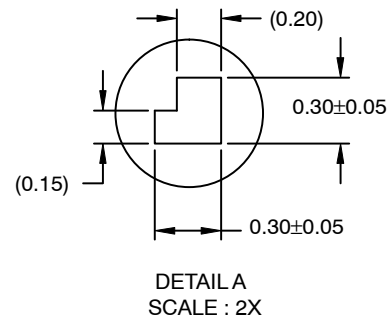
- A. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.



SIDE VIEW



BOTTOM VIEW



**DETAIL A
SCALE : 2X**

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DESCRIPTION:	UQFN8 1.6X1.6, 0.5P	PAGE 1 OF 1

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